



US2AF THRU US2MF

VOLTAGE RANGE 50 to 1000 Volts
CURRENT 2.0 Ampere



Features

- Fast recovery glass passivated chip
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering: 260°C/10S at terminals
- Component in accordance to ROHS 2002/95/1 and WEEE 2002/96/EC



Mechanical Data

- Case: JEDEC SMAF mold plastic Body over glass passivated chip
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D
- Polarity: Laser band denote cathode band
- Weight: 0.00095ounce, 0.028grams

Maximum Ratings and Electrical Characteristics

- Ratings at 25°C ambient temperature unless otherwise specified
- Single phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

TYPE NUMBER		SYMBOL	US 2AF	US 2BF	US 2DF	US 2GF	US 2JF	US 2KF	US 2MF	UNIT
Maximum Repetitive Peak Reverse Voltage		V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage		V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage		V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current At T _A =100°C		I _(AV)	2.0							Amps
Peak Forward Surge Current 8.3ms single half sine wave superimposed on rated load (JEDEC Method)		I _{FSM}	60							Amps
Maximum Instantaneous Forward Voltage per at 2.0A		V _F	1.0			1.30	1.70			Volts
Maximum DC Reverse Current at rated DC Blocking Voltage	T _A = 25°C	I _R	5.0							µA
	T _A = 125°C		100							
Typical Reverse Recovery Time Test conditions (Note 3)		T _{RR}	50				75			nS
Typical Junction Capacitance (Note 2)		C _J	50				30			pF
Typical Thermal Resistance (Note 1)		R _{θJA}	80							°C/W
		R _{θJL}	35							
Operating Junction Temperature		T _J	-55 to +150							°C
Storage Temperature Range		T _{STG}	-55 to +150							°C

Notes:

1. Thermal resistance from Junction to ambient and from junction to lead mounted on PCB. with 0.2×0.2"(5.0 × 5.0mm) copper pad areas.
2. Measured at 1.0MHz and applied reverse voltage of 4.0V
3. Reverse Recovery Test Conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{RR}=0.25\text{A}$.



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Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

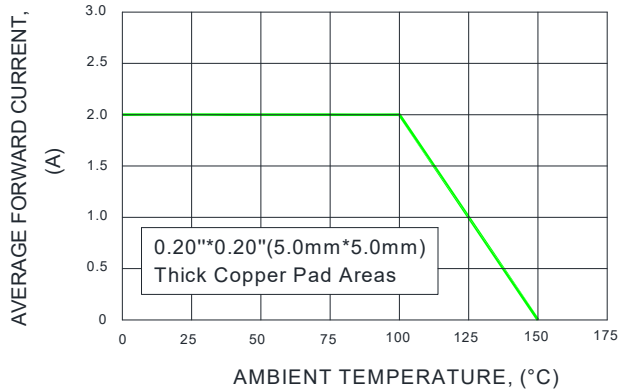


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

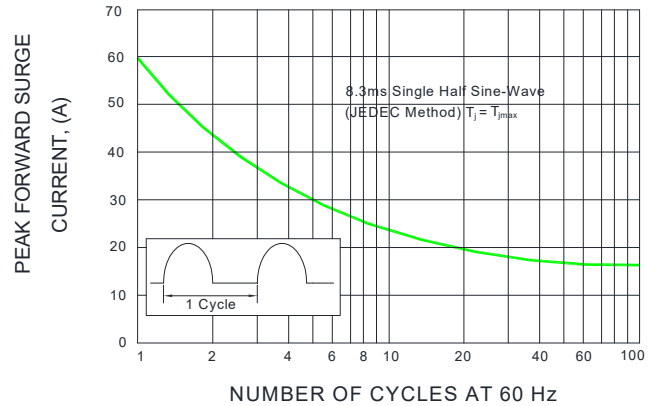


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

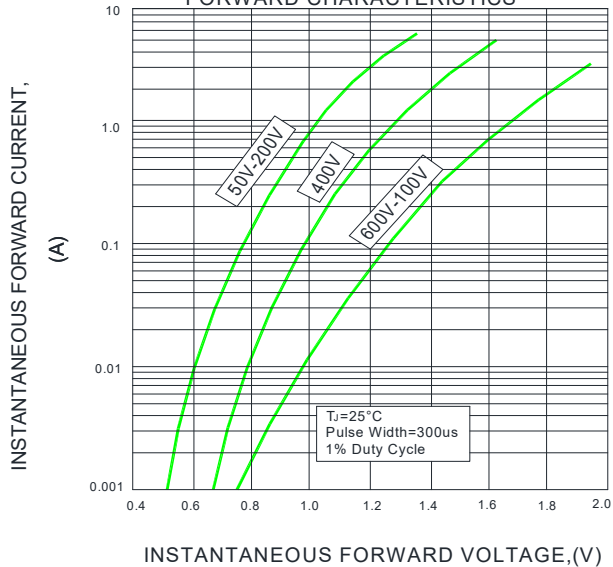


FIG.4-TYPICAL REVERSE CHARACTERISTICS

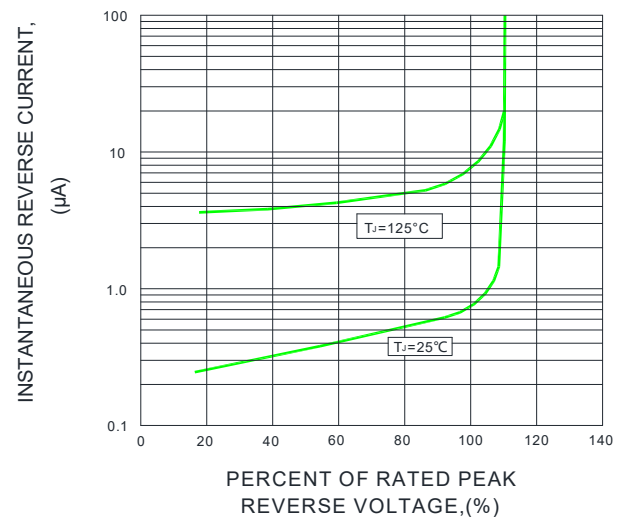


FIG.5-TYPICAL JUNCTION CAPACITANCE

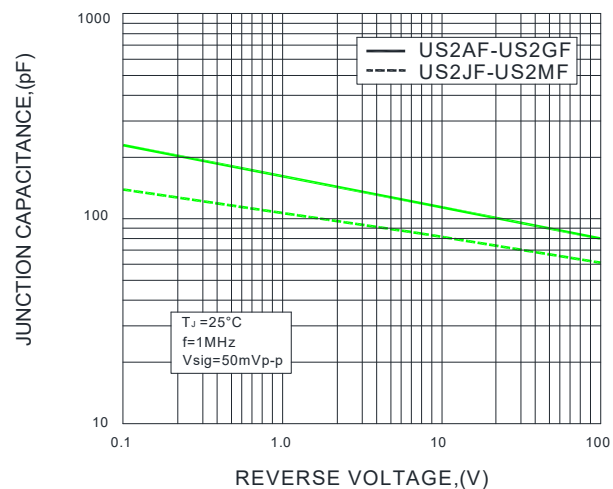
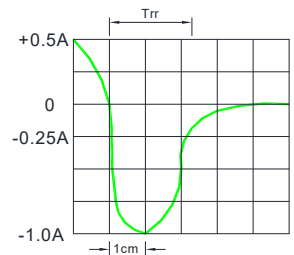
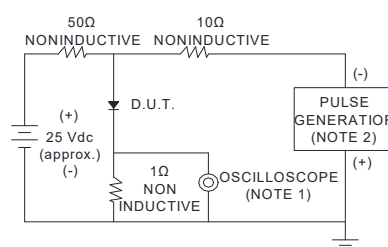


FIG.6-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



NOTES : 1. Rise Time=7ns max. Input Impedance=1 magohm, 22pF
2. Rise time=10ns max. Source Impedance=50 ohms

SET TIME BASE FOR 50/100ns/cm

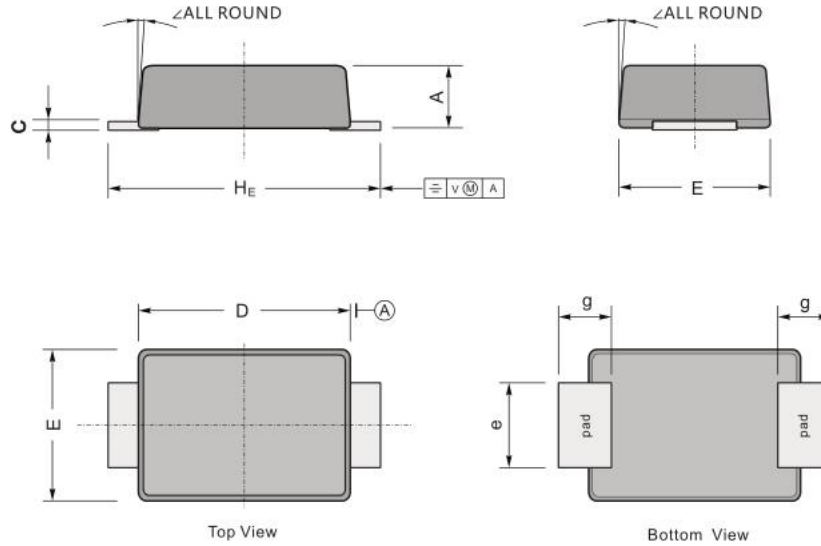


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Package Outline Dimensions in inches (millimeters)



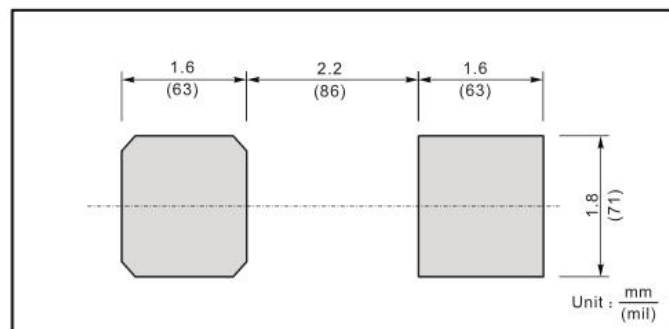
UNIT		A	C	D	E	e	g	H _E	∠
mm	max	1.10	0.20	3.70	2.70	1.60	1.20	4.90	5-7°
	min	0.90	0.12	3.30	2.40	1.30	0.80	4.40	
mil	max	43	7.90	146	106	63	47	193	
	min	35	4.70	130	94	51	31	173	

The Recommended Mounting Pad Size

Marking

Type number	Marking code
US2AF	US2A
US2BF	US2B
US2DF	US2D
US2GF	US2G
US2JF	US2J
US2KF	US2K
US2MF	US2M

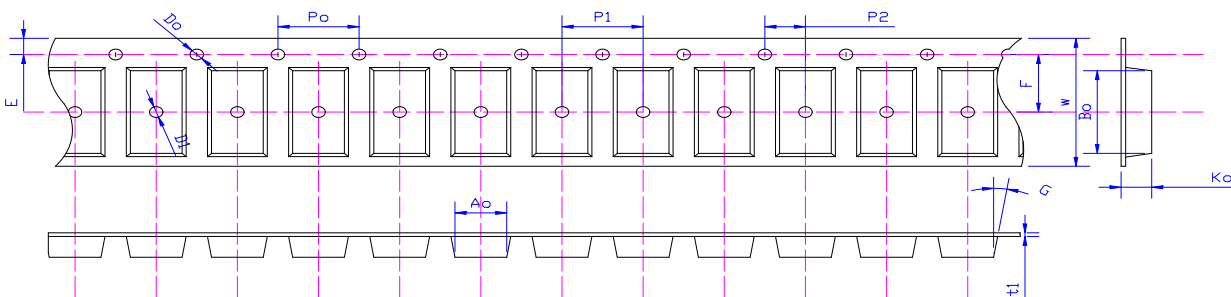
The recommended mounting pad size





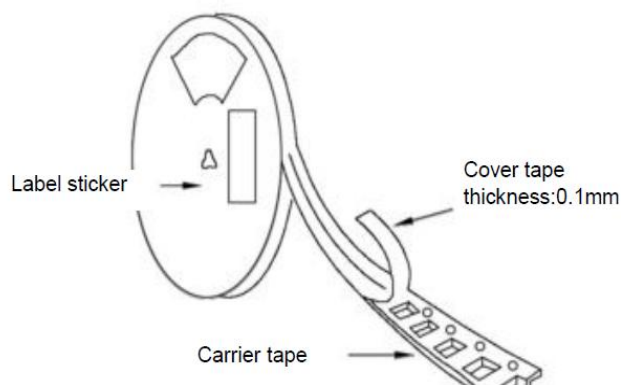
Packing Requirments

- PS black anti-static carrier tape packing



Specifications	Ao	Bo	Ko	Po	W	t1
SMAFL	2.83±0.10	4.90±0.10	1.45±0.10	4.00±0.1	12.0±0.05	0.23±0.02

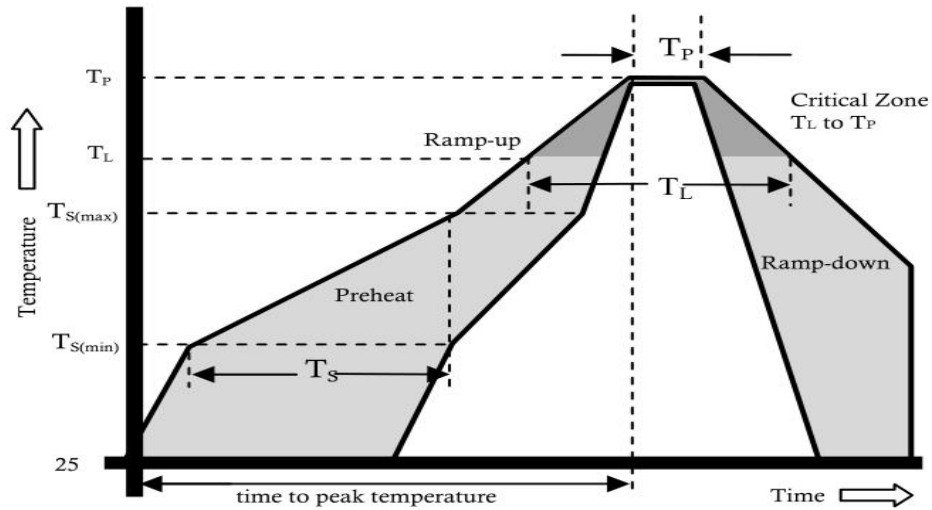
- 13 "antistatic plastic reel



DEVICE TYPE	13" Reel			
	Q'TY/REEL(pcs)	REEL/BOX	BOX/CARTOON	Q'TY/CARTON(pcs)
SMAFL	10000	2	8	160000



Reflow Profile



Reflow Condition		Pb-Free Assembly
Pre Heat	Temperature Min.	+150°C
	Temperature Max.	+200°C
	Time(Min to Max)	60-180 secs.
Average ramp up rate(Liquidus Temp(T_L) to peak)		3°C/sec. Max.
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max.
Reflow	Temperature (T_L)(Liquidus)	+217°C
	Temperature (T_L)	60-150 secs.
Peak Temp (T_P)		+(260+0/-5)°C
Time within 5°C of actual Peak Temp (T_P)		25 secs.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to peak Temp (T_P)		8 min. Max.
Do not exceed		+260°C



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